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# **SBS5150 SCHOTTKY RECTIFIER**

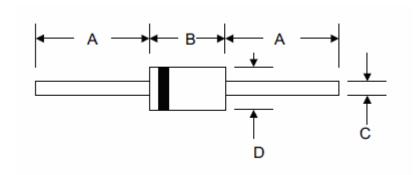
## **Applications:**

- Switching power supply
- Converters
- Free-Wheeling diodes
- Reverse battery protection
- Disk drives
- Battery charging

#### Features:

- Schottky Barrier Chip
- Guard Ring Die Construction for Transient Protection
- High Current Capability
- Low Power Loss, High Efficiency
- High Surge Current Capability
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Applications
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

#### Mechanical Dimensions: In mm/Inches



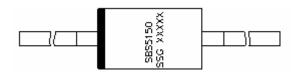
	DO-201AE			
Dim	Min	Max	Min	Max
Α	25.4	-	1.000	-
В	7.20	9.50	0.283	0.374
С	0.94	1.07	0.037	0.042
D	4.80	5.30	0.189	0.209
All	In mm		In inch	

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## **Marking Diagram:**



Where XXXXX is YYWWL

SBS = Device Type

5 = Forward Current (5A) 150 = Reverse Voltage (150V)

SSG = SSG YY = Year WW = Week L = Lot Number

Cautions: Molding resin

Epoxy resin UL:94V-0

## **Maximum Ratings:**

Characteristics	Symbol	Condition	Max.	Units
Peak Inverse Voltage	$V_{RWM}$	-	150	V
Average Forward Current	I <sub>F(AV)</sub>	50% duty cycle @T <sub>C</sub> =105°C, rectangular wave form	5	А
Peak One Cycle Non-Repetitive Surge Current (per leg)	I <sub>FSM</sub>	8.3 ms, half Sine pulse	120	А

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## **Electrical Characteristics:**

Characteristics	Symbol	Condition	Max.	Units
Forward Voltage Drop(per leg)*	$V_{F1}$	@ 5A, Pulse, T <sub>J</sub> = 25 °C	0.93	V
	$V_{F2}$	@ 5A, Pulse, T <sub>J</sub> = 125 °C	0.80	V
Reverse Current at DC	I <sub>R1</sub>	@V <sub>R</sub> = rated VR	1	mA
condition		$T_J = 25  ^{\circ}C$		
Reverse Current *	$I_{R2}$	@V <sub>R</sub> = rated VR	7.0	mA
		T <sub>J</sub> = 125 °C		
Junction Capacitance	Ст	$@V_R = 5V, T_C = 25  ^{\circ}C$	200	pF
		f <sub>SIG</sub> = 1MHz		
Typical Series Inductance	Ls	Measured lead to lead 5 mm	8.0	nΗ
		from package body		
Voltage Rate of Change	dv/dt	-	10,000	V/μs

<sup>\*</sup> Pulse Width < 300µs, Duty Cycle <2%

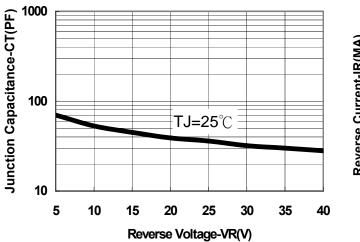
# **Thermal-Mechanical Specifications:**

Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	$T_J$	-	-55 to +150	°C
Storage Temperature	T <sub>stg</sub>	-	-55 to +150	°C
Maximum Thermal Resistance Junction to Case	$R_{\theta JC}$	DC operation	4.5	°C/W
Approximate Weight	wt	-	1.02	g
Case Style	DO-201AE			

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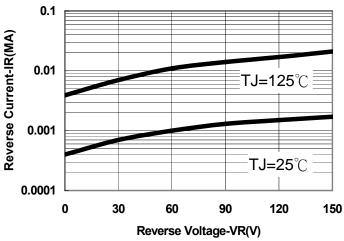


Fig.1-Typical Junction Capacitance

Fig.2-Typical Reverse Characteristics

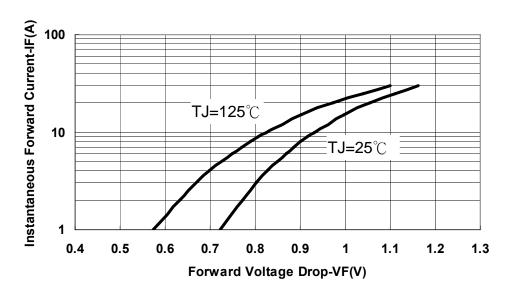


Fig.3-Typical Instantaneous Forward Voltage Characteristics

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# Technical Data Green Products Data Sheet N1560 Rev. -

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